





Fast Si PIN photo diode IP-Si 106. IP-Si 106-A

Characteristics:

Planar Front Incident Structure .

Fast Response.

Low Dark Current .

High Responsivity.

High Reliability .



Distance measurement

0.4-1.1µm Transient Process

Fast Physical and Chemical Process Optical detection

Light Detection, YAG Pulse Power measurement, and

Fiber Optical Communication Detection



Mechanism

The device is a compound Si-PIN structure. To reach high response, back side hole etching process is used for thinner I layer, when carrier go through the floating area, optical current will appear .Slow optical carrieIP are shorted for fast response purpose.

Technical Parameter(TA=23°€)

	Parameter	Symbol Φ	Test Conditions	Typical GT106 GT106-A		Unit
	Active Area			100	100 (GT106-A)	μm
Optical Parameter	Spectrum Response Range	λ		500~1100		nm
	Responsivity	Re	V _R =15∨ λ=900nm	0.3	0.3	AW
	Response Time	tr	V _R =15∨		0.7	nS
	Couple loss	η			1	db
Electrical Parameter	Dark Current	l _o	V _R =15∨	1	1	nA
	Reverse Break Down Voltage	V_{BR}	I _R =10µA	40	40	V
	Capacitance	Cj	f=1MHz V _R =40V		0.8	pF
Operating Voltage		V_{R}			15	V
Package			Coaxial II			
		Satu	ration Power <u>≤0</u> .*	1w/cm²		







Typical Operating Characteristics:

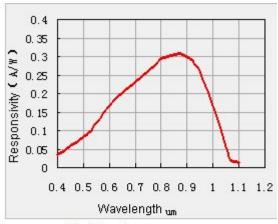
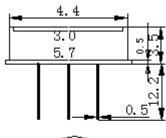


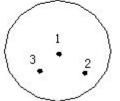
Fig.1 Spectrum response curve

30

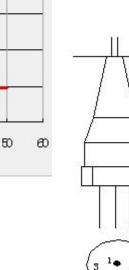
Voltage (ξ) Fig.2 C-V curve 40

Package and the usage(Lead is numbered from the back side)



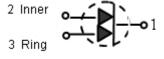


Coaxial II



Coaxial II with the fiber

3-0.4



Note:

2

1

0.5

0

0

10

20

1.5

Capacitance (PF)

ReveIPe Bias; No Vibration and shock when device operating; Static Charge Protection (Storage, Operating); Clean the fiber tip with degrease cotton and ethanol.